

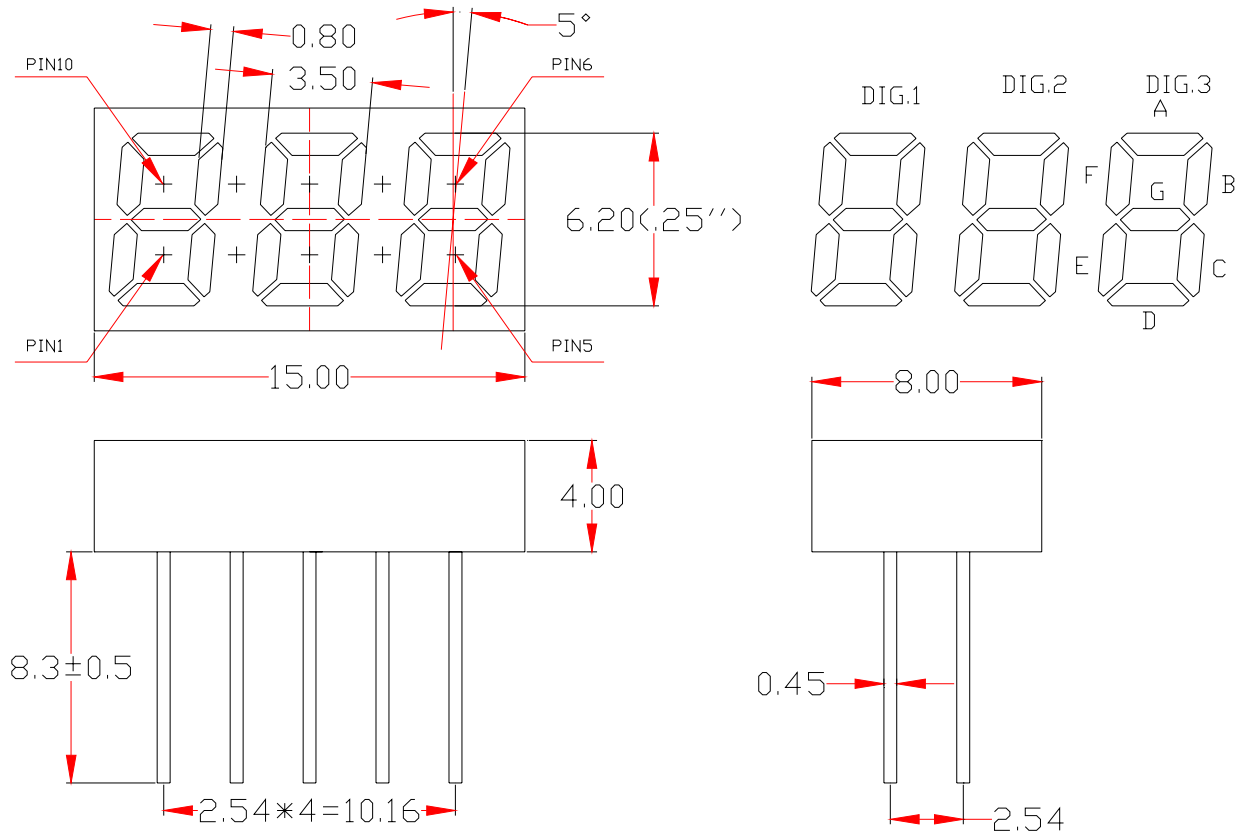
# **WCN3-0025B7-A12-H**

## **SPECIFICATION**

<b>WCN</b>			<b>CUSTOMER Confirmed</b>
<b>Prepared by</b>	<b>Checked by</b>	<b>Approved by</b>	
<b>Fei</b> <b>2016-6-6</b>	<b>Athena</b>	<b>William</b>	
<b>REVISION RECORD</b>			

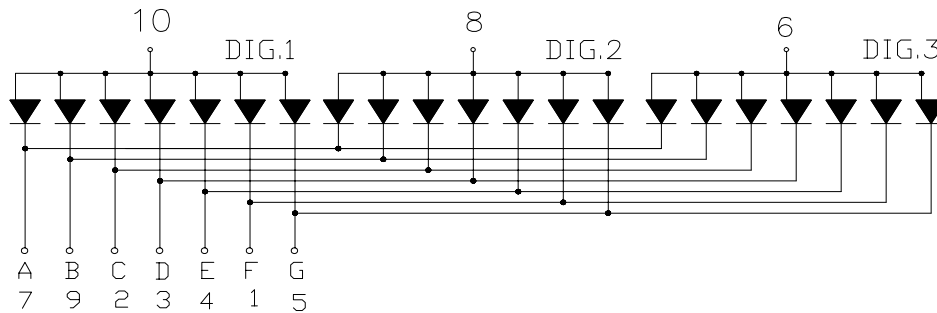
**REVISION: A0**

### Outer Dimension:



Notes: Unless otherwise stated, The tolerance is  $\pm 0.25\text{mm}$ .

### Circuit Diagram:



### Pin Connection:

PIN NO.	CONNECTION	PIN NO.	CONNECTION
1	Cathode F	6	Common Anode Dig. 3
2	Cathode C	7	Cathode A
3	Cathode D	8	Common Anode Dig. 2
4	Cathode E	9	Cathode B
5	Cathode G	10	Common Anode Dig. 1

# WCN Opto Group Co., Limited

## ■ Features:

- High Reliability
- Color: Blue
- Low Power Requirement
- Easy Assembly

## ■ Description:

- Three Digit Display
- Digit Height:6.2mm(0.25" )
- Black Face and Milky Segment

## ■ Absolute Maximum Rating (Ta=25°C):

Parameter	Symbol	Condition	Color	Rating	Units
Power Dissipation Per Segment	P <sub>d</sub>	—	Blue	90	mW
Forward Current Per Segment	I <sub>F</sub>	—	Blue	25	mA
Peak Forward Current Per Segment	I <sub>FP</sub>	1/10 Duty 10KHz	Blue	100	mA
Reverse Voltage Per Segment	V <sub>R</sub>	—	Blue	5	V
Operating Temperature Range	T <sub>opr</sub>	—	—	-40~+110	°C
Storage Temperature Range	T <sub>stg</sub>	—	—	-40~+110	°C

## ■ Electrical/Optical Characteristics Rating(Ta=25°C)

Item	Symbol	Test conditions	Location	Rating			Units
				Min.	Typ.	Max.	
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	Per Segment	—	3.2	3.60	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	Per Segment	—	—	100	μA
Luminous Intensity	I <sub>V</sub>	I <sub>F</sub> =10mA	Per Segment	6101	9500	15250	μcd
Peak Emission Wave Length	λ <sub>P</sub>	I <sub>F</sub> =20mA	Per Segment	—	—	—	nm
	λ <sub>D</sub>			465	470	475	
Spectral Line Half Width	△λ	I <sub>F</sub> =20mA	Per Segment	—	20	—	nm
Luminous Intensity Matching Ratio (Segment to Segment)	I <sub>v-m</sub>	I <sub>F</sub> =10mA	—	—	—	1.2:1	

## ■ Luminous Intensity Sorting: (Luminous Intensity Tolerance is +/-10%)

Rank	Symbol	Condition	Min	Max	Unit
N	N	I <sub>F</sub> =10mA	6101	7200	μcd
O	O	I <sub>F</sub> =10mA	7201	8500	μcd
P	P	I <sub>F</sub> =10mA	8501	10500	Mcd
Q	Q	I <sub>F</sub> =10mA	10501	12800	μcd
R	R	I <sub>F</sub> =10mA	12801	15250	μcd

■ Soldering Conditions: Soldering Temp. ≤+260°C, Soldering Time. ≤3sec.  
(at 2mm Distance from The Case of Reflector Edge)

**Typical Elector-Optical Characteristics Curve:**

Fig1. Forward Current vs. Forward Voltage:

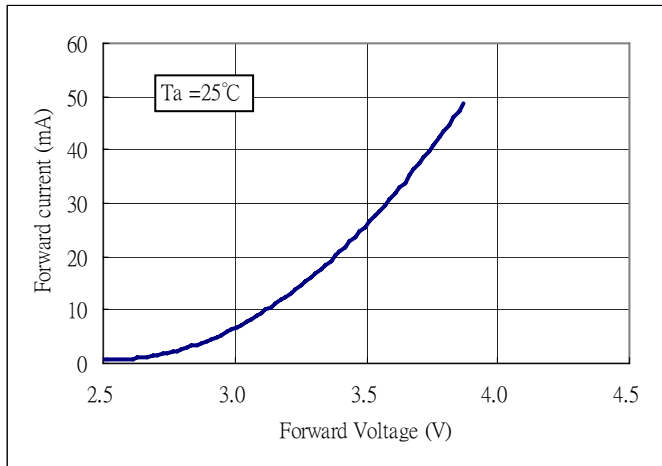


Fig2. Forward Current vs. Relative Intensity:

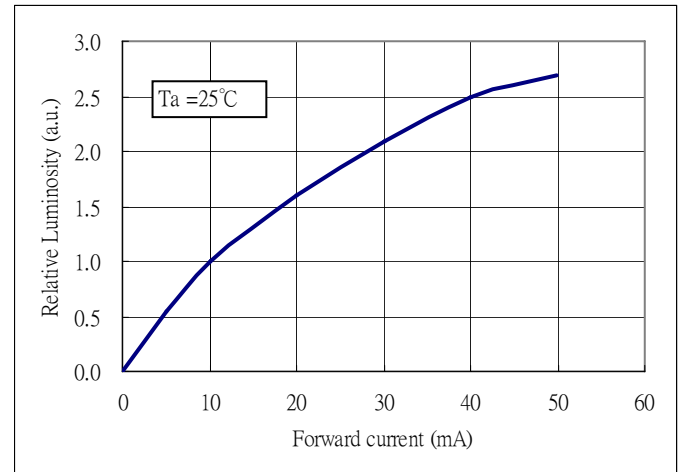


Fig3. Forward Current vs. Relative wavelength:

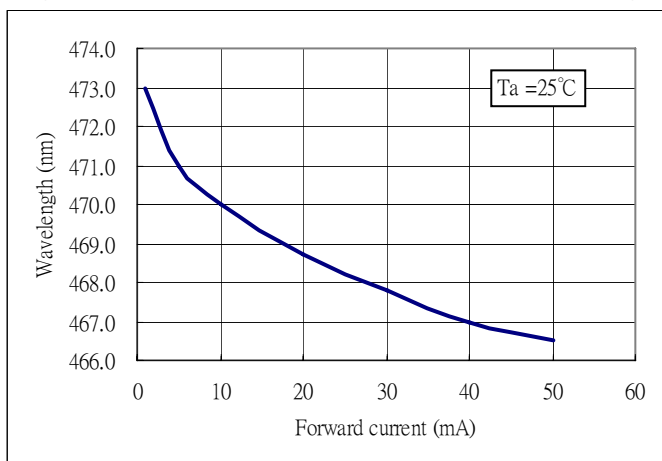
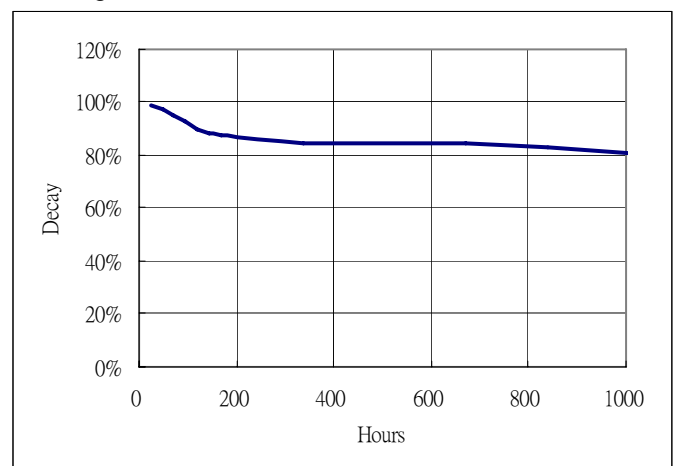


Fig4. Life Test at 20mA R.T. 1000hrs:



## ■ LED Displays Reliability Test:

CLASSIFICATION	TEST ITEM	DESCRIPTION AND TEST CONDITION
ENDURANCE TEST	OPERATION LIFE	EVALUATES RESISTANCE OF THE DEVICE WHEN OPERATED AT ELECTRICAL STRESS $T_a$ = UNDER ROOM TEMPERATURE $I_f = I_f \text{ max}$
	HIGH TEMPERATURE HIGH HUMIDITY STORAGE	EVALUATES MOISTURE RESISTANCE OF THE DEVICE WHEN STORED FOR A LONG TERM AT HIGH TEMPERATURE AND HUMIDITY $T_a = 65 \pm 5^\circ\text{C}$ RH=90~95%RH TEST TIME=240± 2Hrs
	HIGH TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN HIGH TEMPERATURE $T_a = 85 \pm 5^\circ\text{C}$ (COB: $T_a = 65 \pm 5^\circ\text{C}$ ) TEST TIME=1000Hrs(-24Hrs, +72Hrs)
	LOW TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN LOW TEMPERATURE $T_a = -35 \pm 5^\circ\text{C}$ TEST TIME=1000Hrs(-24Hrs, +72Hrs)
ENVIRONMENTAL TEST	TEMPERATURE CYCLING	EVALUATES RESISTANCE OF DEVICE AT THERMAL STRESSES OR EXPANSION AND CONTRACTION $85^\circ\text{C} \sim 25^\circ\text{C} \sim -35^\circ\text{C} \sim 25^\circ\text{C}$ 30min 5min 30min 5min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$ , $T_{\text{cold}}=-25^\circ\text{C}$ )
	THERMAL SHOCK	EVALUATES DEVICE STRUCTURE AND STRUCTURE AND MECHANICAL RESISTANCE WHEN SUDDENLY EXPOSED AT SERVE CHANGES $85 \pm 5^\circ\text{C} \sim -35 \pm 5^\circ\text{C}$ 10min 10min 10 CYCLES(COB: $T_{\text{hot}}=65^\circ\text{C}$ , $T_{\text{cold}}=-25^\circ\text{C}$ )
	SOLDERABILITY	EVALUATES SOLDERABILITY ON LEADS OF DEVICE $T_{\text{SOL}}=230 \pm 5^\circ\text{C}$ DWELL TIME=5±1sec.
	SOLDER RESISTANCE	EVALUATES RESISTANCE TO THERMAL STRESS CAUSED BY SOLDERING $T_{\text{SOL}}=260 \pm 5^\circ\text{C}$ DWELL TIME=10±1sec.

## ■ Packing method A:

**360 pcs / Red Expandable Polyethylene.**

**2160 pcs / Box(360\*175\*130mm).**

**12960 pcs / Carton(550\*380\*280mm).**

## ■ Packing method B:

**33 pcs / IC Tube.(520\*10.4\*18.4)**

**3267 pcs / Box(537\*175\*125mm).**

**13068 pcs / Carton(550\*380\*280mm).**